

60 V, 1 A NPN/NPN low VCEsat (BISS) transistor

11 February 2015

Product data sheet

1. General description

NPN/NPN low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a leadless medium power DFN2020D-6 (SOT1118D) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

NPN/PNP complement: PBSS4160PANPS. PNP/PNP complement: PBSS5160PAPS.

2. Features and benefits

- Very low collector-emitter saturation voltage V_{CEsat}
- High collector current capability ${\rm I}_{\rm C}$ and ${\rm I}_{\rm CM}$
- High collector current gain h_{FE} at high I_C
- Reduced Printed-Circuit Board (PCB) requirements
- · Exposed heat sink for excellent thermal and electrical conductivity
- High energy efficiency due to less heat generation
- Suitable for Automatic Optical Inspection (AOI) of solder joints
- AEC-Q101 qualified

3. Applications

- Load switch
- Battery-driven devices
- Power management
- Charging circuits
- LED lighting
- Power switches (e.g. motors, fans)

4. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transistor							
V _{CEO}	collector-emitter voltage	open base		-	-	60	V
I _C	collector current			-	-	1	А
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-	1.5	А



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Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Per transistor							
R _{CEsat}	collector-emitter saturation resistance	I _C = 0.5 A; I _B = 50 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C		-	-	240	mΩ

5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E1	emitter TR1	6 5 4	C1 B2 E2
2	B1	base TR1		
3	C2	collector TR2	7 8	
4	E2	emitter TR2		
5	B2	base TR2	1 2 3	E1 B1 C2
6	C1	collector TR1	Transparent top view DFN2020D-6 (SOT1118D)	sym140
7	C1	collector TR1	DI 142020D-0 (SOTTIOD)	
8	C2	collector TR2		

6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PBSS4160PANS	DFN2020D-6	DFN2020D-6: plastic, thermally enhanced ultra thin and small outline package; no leads; 6 terminals; body 2 x 2 x 0.65 mm	SOT1118D			

7. Marking

Table 4. Marking codes	
Type number	Marking code
PBSS4160PANS	3F

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8. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transis	tor					
V _{CBO}	collector-base voltage	open emitter		-	60	V
V _{CEO}	collector-emitter voltage	open base		-	60	V
V _{EBO}	emitter-base voltage	open collector		-	7	V
lc	collector current			-	1	А
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	1.5	А
I _B	base current			-	0.3	А
ВМ	peak base current	single pulse; t _p ≤ 1 ms		-	1	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	370	mW
			[2]	-	570	mW
			[3]	-	530	mW
			[4]	-	700	mW
			[5]	-	450	mW
			[6]	-	760	mW
			[7]	-	700	mW
			[8]	-	1450	mW
Per device				1		_
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	510	mW
			[2]	-	780	mW
			[3]	-	730	mW
			[4]	-	960	mW
			[5]	-	620	mW
			[6]	-	1040	mW
			[7]	-	960	mW
			[8]	-	2000	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².

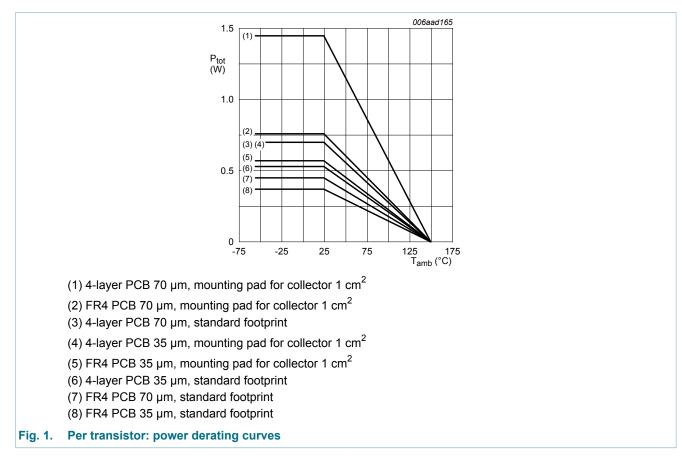
[3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.

^[4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².

[5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.

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- [6] Device mounted on an FR4 PCB, single-sided 70 μm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.
- [8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm².



9. Thermal characteristics

Table 6. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transistor							
R _{th(j-a)}	thermal resistance	in free air [1	[1]	-	-	338	K/W
from junction to ambient		[2]	-	-	219	K/W	
	ampient		[3]	-	-	236	K/W
			[4]	-	-	179	K/W
			[5]	-	-	278	K/W
			[<u>6]</u>	-	-	164	K/W
			[7]	-	-	179	K/W
			[8]	-	-	86	K/W

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	30	K/W
Per device							
R _{th(j-a)}	thermal resistance	in free air	[1]	-	-	245	K/W
from junction to ambient		[2]	-	-	160	K/W	
	ampient		[3]	-	-	171	K/W
			[4]	-	-	130	K/W
			[5]	-	-	202	K/W
			[6]	-	-	120	K/W
			[7]	-	-	130	K/W
			[8]	-	-	63	K/W

- Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated and standard footprint.
 Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.
- [4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.
- [6] Device mounted on an FR4 PCB, single-sided 70 μm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.

[8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm².

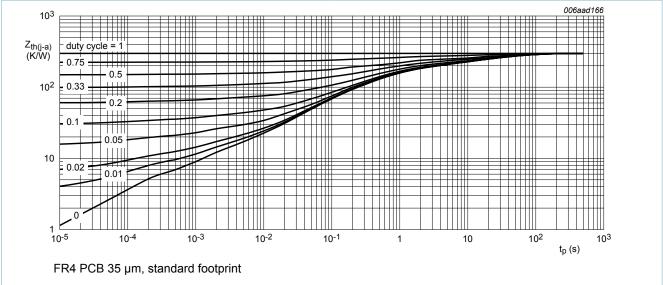
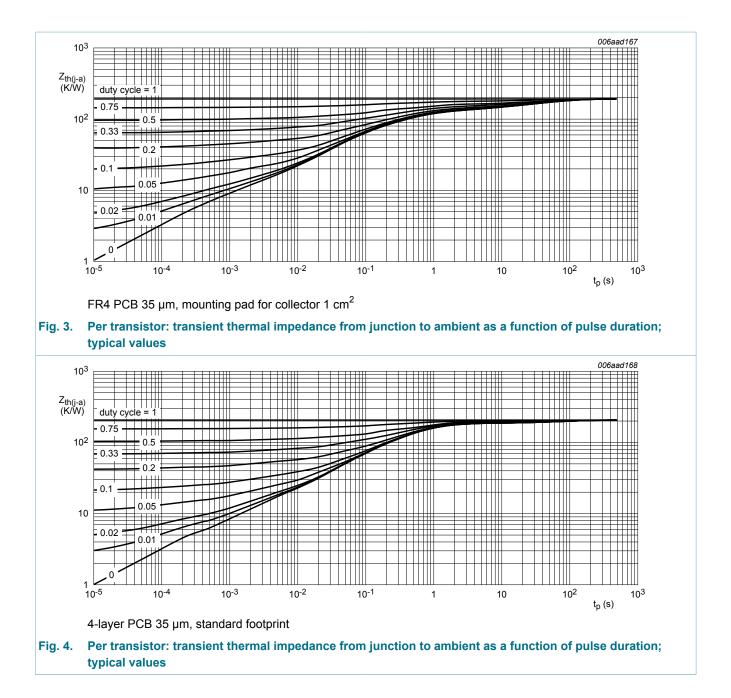


Fig. 2. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values

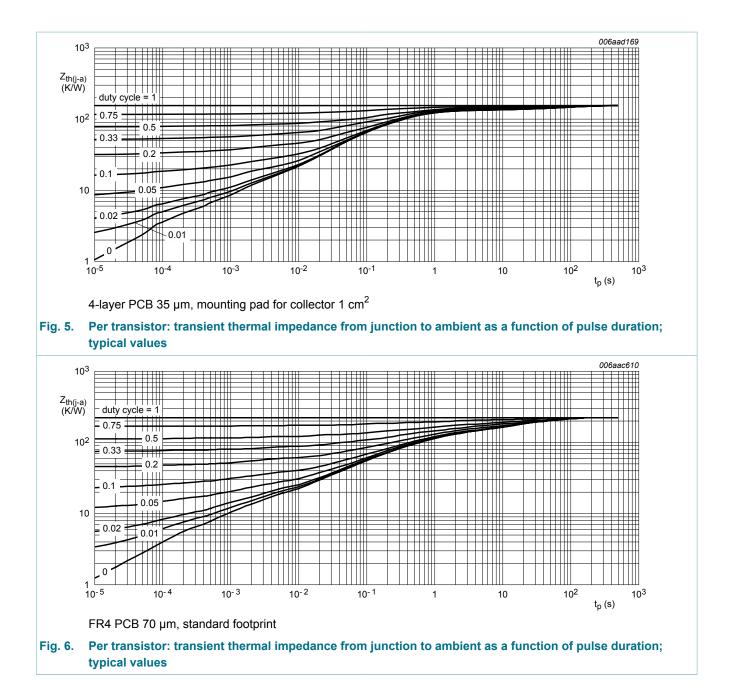


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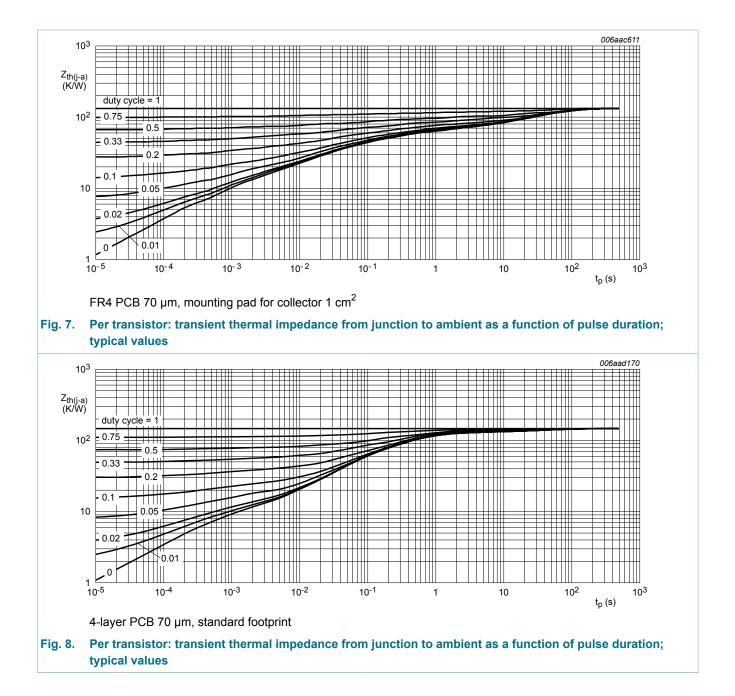
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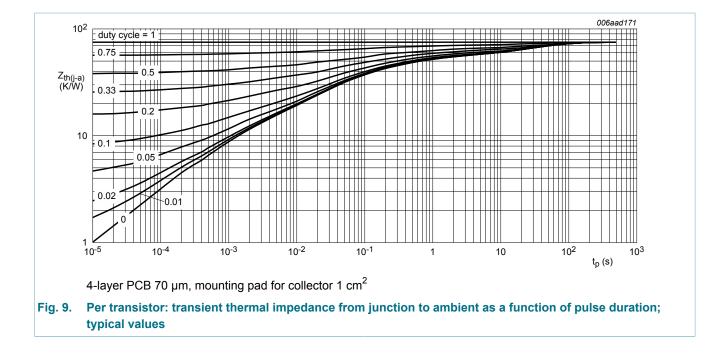
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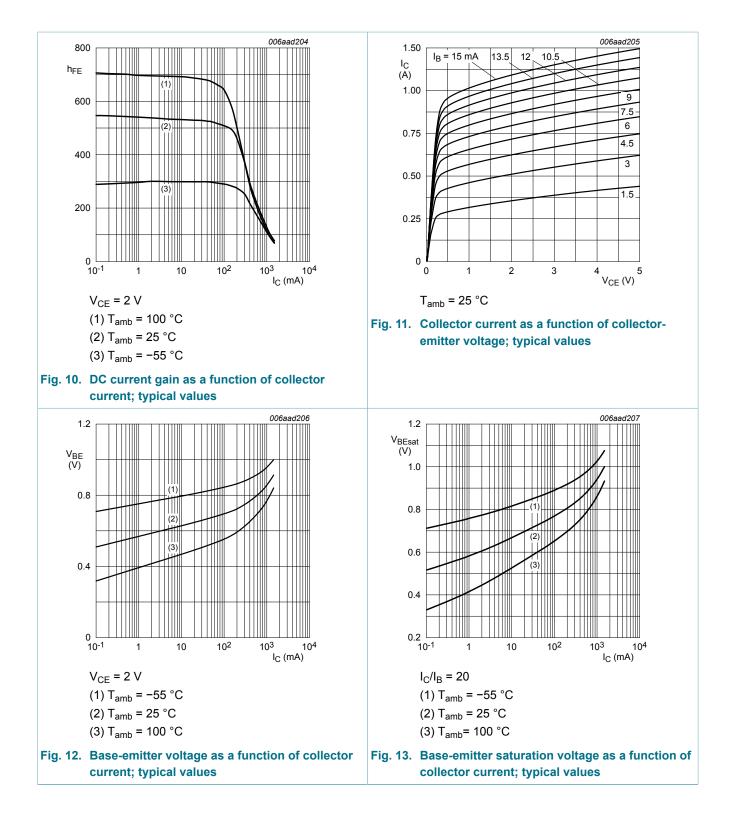
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10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	tor					
I _{CBO}	collector-base cut-off	V_{CB} = 48 V; I _E = 0 A; T _{amb} = 25 °C	-	-	100	nA
	current	V _{CB} = 48 V; I _E = 0 A; T _j = 150 °C	-	-	50	μA
I _{EBO}	emitter-base cut-off current	V_{EB} = 5 V; I _C = 0 A; T _{amb} = 25 °C	-	-	100	nA
h _{FE}	DC current gain	$V_{CE} = 2 \text{ V; } I_C = 100 \text{ mA; pulsed;}$ $t_p \le 300 \mu\text{s; } \delta \le 0.02; T_{amb} = 25 ^\circ\text{C}$	290	430	-	
		$V_{CE} = 2 \text{ V; } I_C = 500 \text{ mA; pulsed;}$ $t_p \le 300 \mu\text{s; } \delta \le 0.02; T_{amb} = 25 ^\circ\text{C}$	150	220	-	
		$\label{eq:Vce} \begin{array}{l} V_{CE} = 2 \; V; \; I_{C} = 1 \; A; \; pulsed; \; t_{p} \leq 300 \; \mu s; \\ \\ \bar{D} \leq 0.02; \; T_{amb} = 25 \; ^{\circ} C \end{array}$	70	110	-	
V _{CEsat}	collector-emitter	I_{C} = 500 mA; I_{B} = 50 mA; T_{amb} = 25 °C	-	90	120	mV
	saturation voltage	I_{C} = 1 A; I_{B} = 50 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	185	240	mV
		I_{C} = 1 A; I_{B} = 100 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	175	220	mV
R _{CEsat}	collector-emitter saturation resistance	I_{C} = 0.5 A; I_{B} = 50 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	-	-	240	mΩ
V _{BEsat}	base-emitter saturation	I_{C} = 500 mA; I_{B} = 50 mA; T_{amb} = 25 °C	-	-	1	V
	voltage	$\begin{split} &I_{C} = 1 \text{ A}; \ I_{B} = 50 \text{ mA}; \text{ pulsed}; \\ &t_{p} \leq 300 \mu\text{s}; \ \overline{\delta} \leq 0.02; \ T_{amb} = 25 \ ^{\circ}\text{C} \end{split}$	-	-	1.1	V
		$\begin{split} I_C &= 1 \text{ A}; I_B = 100 \text{ mA}; \text{ pulsed}; \\ t_p &\leq 300 \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 ^\circ\text{C} \end{split}$	-	-	1.1	V
V _{BEon}	base-emitter turn-on voltage	$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 0.5 \text{ A}; \text{ pulsed};$ $t_{p} \leq 300 \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 ^{\circ}\text{C}$	-	-	0.9	V
t _d	delay time	V_{CC} = 10 V; I _C = 500 mA; I _{Bon} = 25 mA;	-	15	-	ns
t _r	rise time	I _{Boff} = -25 mA; T _{amb} = 25 °C	-	90	-	ns
t _{on}	turn-on time		-	105	-	ns
t _s	storage time		-	410	-	ns
t _f	fall time		-	130	-	ns
t _{off}	turn-off time		-	540	-	ns
f _T	transition frequency	V_{CE} = 10 V; I _C = 50 mA; f = 100 MHz; T _{amb} = 25 °C	90	175	-	MHz
C _c	collector capacitance	V _{CB} = 10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C	-	4	6	pF

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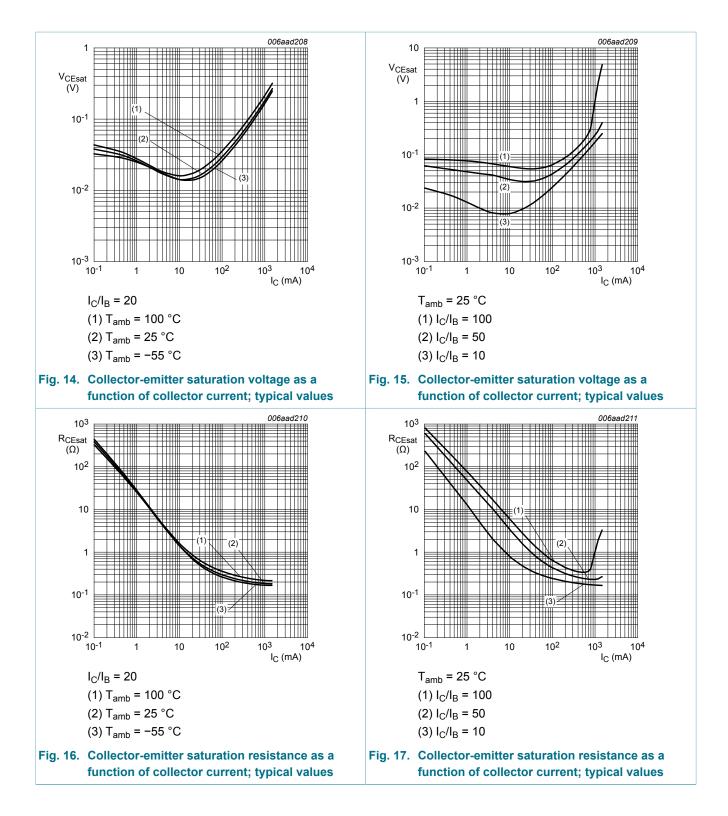
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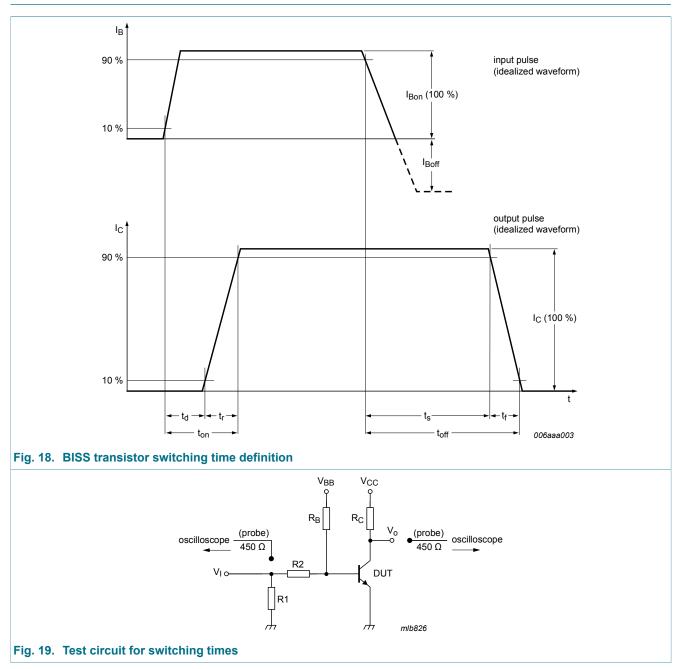
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11. Test information

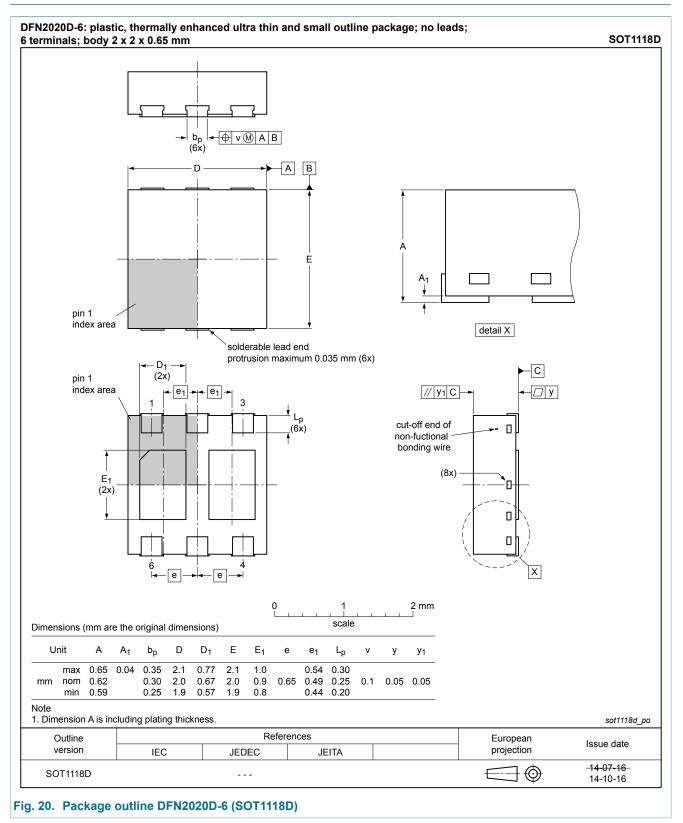
11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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12. Package outline



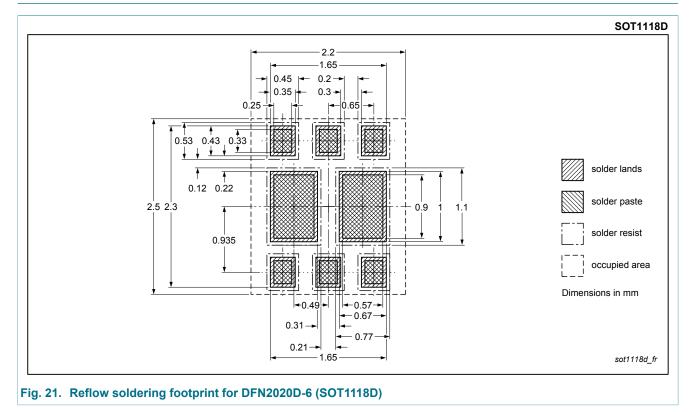
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13. Soldering



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14. Revision history

Table 8. Revision history					
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes	
PBSS4160PANS v.1	20150211	Product data sheet	-	-	

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15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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